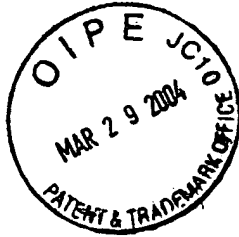


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Sabina J. Houle

Title: COMPOSITE THERMAL INTERFACE DEVICES AND METHODS FOR INTEGRATED  
CIRCUIT HEAT TRANSFER

Docket No.: 884.848US1  
Filed: June 26, 2003  
Examiner: Unknown



Serial No.: 10/608405  
Due Date: N/A  
Group Art Unit: 2818


Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ A Communication Concerning Related Applications (1 pg.).
- ☒ An Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.), and copies of 1 cited documents.

If not provided in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
Customer Number 21186

By:   
Atty: David C. Peterson  
Reg. No. 47,857

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 25 day of March, 2004.

KACIA LEE  
Name

Kacia Lee  
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
(GENERAL)

S/N 10/608405

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Sabina J. Houle Examiner: Unknown  
Serial No.: 10/608405 Group Art Unit: 2818  
Filed: June 26, 2003 Docket: 884.848US1  
Title: COMPOSITE THERMAL INTERFACE DEVICES AND METHODS FOR  
INTEGRATED CIRCUIT HEAT TRANSFER  
Assignee: Intel Corporation Customer No.: 21186

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date</u>	<u>Attorney Docket</u>	<u>Title</u>
10/405095	March 31, 2003	884.827US1	HEAT SINK WITH PREATTACHED THERMAL INTERFACE MATERIAL AND METHOD OF MAKING SAME

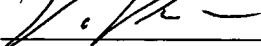
Respectfully submitted,

SABINA J. HOULE

By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
Attorneys for Intel Corporation  
P.O. Box 2938  
Minneapolis, MN 55402  
(612) 373-6944

Date 3-25-04

By   
David C. Peterson  
Reg. No. 47,857

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 25 day of March, 2004.

Name

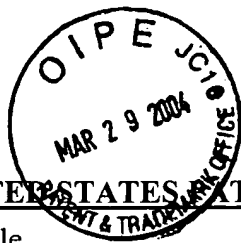
KACIA LEE

Signature

Kacia Lee

S/N 10/608405

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Sabina J. Houle	Examiner:	Unknown
Serial No.:	10/608405	Group Art Unit:	2818
Filed:	June 26, 2003	Docket:	884.848US1
Title:	COMPOSITE THERMAL INTERFACE DEVICES AND METHODS FOR INTEGRATED CIRCUIT HEAT TRANSFER		
Assignee:	Intel Corporation	Customer No:	21186

---

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicant respectfully requests that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicant requests that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicant with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Information Disclosure Statement considered.

INFORMATION DISCLOSURE STATEMENT

Serial No : 10/608405

Filing Date: June 26, 2003

Title: COMPOSITE THERMAL INTERFACE DEVICES AND METHODS FOR INTEGRATED CIRCUIT HEAT TRANSFER

Assignee: Intel Corporation

Page 2

Dkt: 884.848US1 (INTEL)

The Examiner is invited to contact the Applicant's Representative at the below-listed telephone number if there are any questions regarding this communication.


Respectfully submitted,

SABINA J. HOULE

By her Representatives,

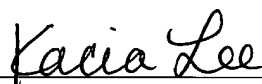
SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
Attorneys for Intel Corporation  
P.O. Box 2938  
Minneapolis, Minnesota 55402  
(612) 373-6944

Date 3-25-04

By   
David C. Peterson  
Reg. No. 47,857

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 25 day of March, 2004.

Name KACIA LEE

Signature 

Substitute for form 1449A/PTO

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(Use as many sheets as necessary)



Complete if Known

Application Number	10/608405
Filing Date	June 26, 2003
First Named Inventor	Houle, Sabina
Group Art Unit	2818
Examiner Name	Unknown

Sheet 1 of 1

Attorney Docket No: 884.848US1

**US PATENT DOCUMENTS**

Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	Filing Date If Appropriate
	US-6,504,242	01/07/2003	Deppisch, Carl L., et al.	257	707	11/15/2001

**FOREIGN PATENT DOCUMENTS**

Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	T <sup>2</sup>
--------------------	---------------------	------------------	---	-------	----------	----------------

**OTHER DOCUMENTS -- NON PATENT LITERATURE DOCUMENTS**

Examiner Initials*	Cite No <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>2</sup>
--------------------	----------------------	---	----------------

**EXAMINER****DATE CONSIDERED**